



ALPHA & OMEGA
SEMICONDUCTOR, LTD

AO4423

P-Channel Enhancement Mode Field Effect Transistor

Rev 4: May 2005



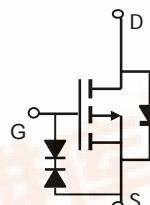
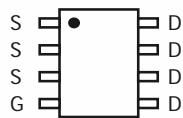
General Description

The AO4423 uses advanced trench technology to provide excellent $R_{DS(ON)}$, and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications. It is ESD protected. AO4423L (Green Product) is offered in a lead-free package. AO4423 is Pb-free (meets ROHS & Sony 259 specifications). AO4423L is a Green Product ordering option. AO4423 and AO4423L are electrically identical.

Features

V_{DS} (V) = -30V
 I_D = -15A
 $R_{DS(ON)} < 7m\Omega$ (V_{GS} = -20V)
 $R_{DS(ON)} < 8.5m\Omega$ (V_{GS} = -10V)
 ESD Rating: 6000V HBM

SOIC-8
Top View



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

| Parameter | Symbol | Maximum | Units |
|--|----------------|------------|-------|
| Drain-Source Voltage | V_{DS} | -30 | V |
| Gate-Source Voltage | V_{GS} | ± 25 | V |
| Continuous Drain Current ^A | I_D | -15 | A |
| $T_A=70^\circ C$ | I_D | -12.1 | |
| Pulsed Drain Current ^B | I_{DM} | -80 | |
| Power Dissipation ^A | P_D | 3.1 | W |
| $T_A=70^\circ C$ | P_D | 2 | |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 150 | °C |

Thermal Characteristics

| Parameter | Symbol | Typ | Max | Units |
|--|-----------------|-----|-----|-------|
| Maximum Junction-to-Ambient ^A | $R_{\theta JA}$ | 26 | 40 | °C/W |
| Steady-State | | 50 | 75 | °C/W |
| Maximum Junction-to-Lead ^C | $R_{\theta JL}$ | 14 | 24 | °C/W |

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|-----------------------------|---------------------------------------|---|-----|------------|--------------|------------------|
| STATIC PARAMETERS | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $I_D=-250\mu\text{A}, V_{GS}=0\text{V}$ | -30 | | | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=-24\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$ | | | -100 -500 | nA |
| I_{GSS} | Gate-Body leakage current | $V_{DS}=0\text{V}, V_{GS}=\pm20\text{V}$ | | | ± 1 | μA |
| | | $V_{DS}=0\text{V}, V_{GS}=\pm25\text{V}$ | | | ± 10 | μA |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_D=-250\mu\text{A}$ | -2 | -2.7 | -3.5 | V |
| $I_{D(\text{ON})}$ | On state drain current | $V_{GS}=-10\text{V}, V_{DS}=-5\text{V}$ | -80 | | | A |
| $R_{DS(\text{ON})}$ | Static Drain-Source On-Resistance | $V_{GS}=-20\text{V}, I_D=-15\text{A}$ $T_J=125^\circ\text{C}$ | | 5.7 7.1 | 7 | $\text{m}\Omega$ |
| | | $V_{GS}=-10\text{V}, I_D=-15\text{A}$ | | 6.8 | 8.5 | $\text{m}\Omega$ |
| | | $V_{GS}=-6\text{V}, I_D=-10\text{A}$ | | 9.4 | 12 | $\text{m}\Omega$ |
| g_{FS} | Forward Transconductance | $V_{DS}=-5\text{V}, I_D=-15\text{A}$ | | 43 | | S |
| V_{SD} | Diode Forward Voltage | $I_S=-1\text{A}, V_{GS}=0\text{V}$ | | -0.71 | -1 | V |
| I_S | Maximum Body-Diode Continuous Current | | | | -4.2 | A |
| DYNAMIC PARAMETERS | | | | | | |
| C_{iss} | Input Capacitance | $V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$ | | 4632 | | pF |
| C_{oss} | Output Capacitance | | | 1034 | | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 705 | | pF |
| R_g | Gate resistance | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$ | | 2.5 | | Ω |
| SWITCHING PARAMETERS | | | | | | |
| Q_g | Total Gate Charge | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, I_D=-15\text{A}$ | | 82 | | nC |
| Q_{gs} | Gate Source Charge | | | 16.8 | | nC |
| Q_{gd} | Gate Drain Charge | | | 23 | | nC |
| $t_{D(\text{on})}$ | Turn-On DelayTime | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=1.0\Omega, R_{\text{GEN}}=3\Omega$ | | 18.5 | | ns |
| t_r | Turn-On Rise Time | | | 20 | | ns |
| $t_{D(\text{off})}$ | Turn-Off DelayTime | | | 55 | | ns |
| t_f | Turn-Off Fall Time | | | 30 | | ns |
| t_{rr} | Body Diode Reverse Recovery Time | $I_F=-15\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | | 43 | | ns |
| Q_{rr} | Body Diode Reverse Recovery Charge | $I_F=-15\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | | 38 | | nC |

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user's specific board design. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The SOA curve provides a single pulse rating.

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AO4423, AO4423L

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

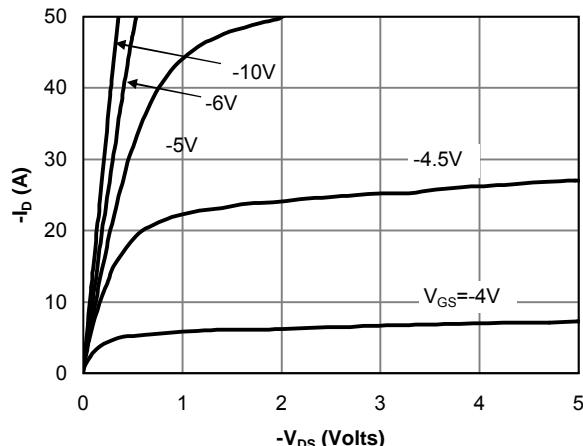


Fig 1: On-Region Characteristics

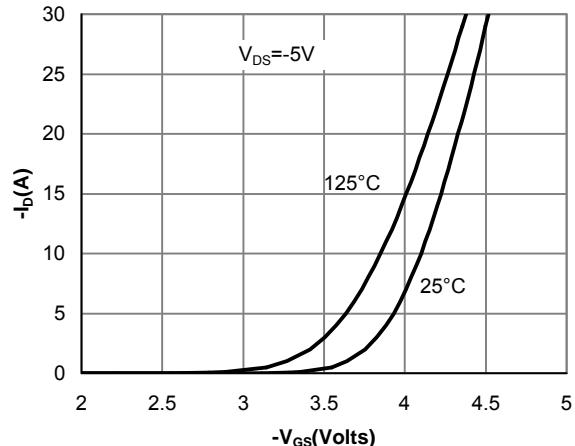


Figure 2: Transfer Characteristics

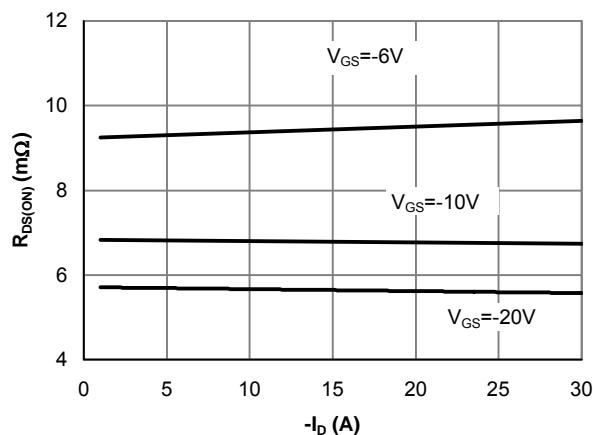


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

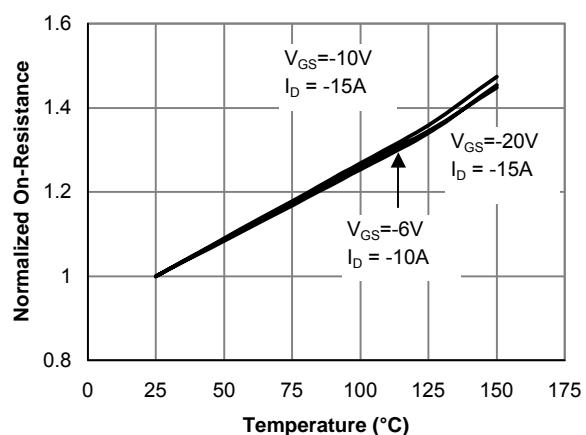


Figure 4: On-Resistance vs. Junction Temperature

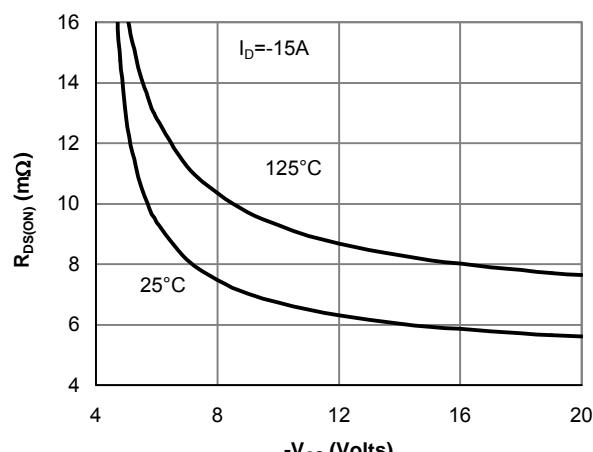


Figure 5: On-Resistance vs. Gate-Source Voltage

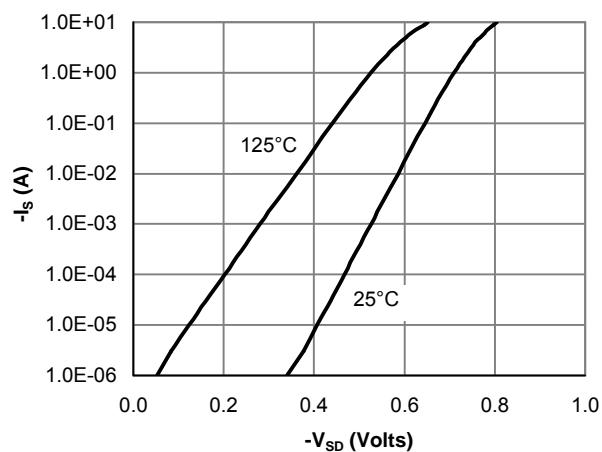


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

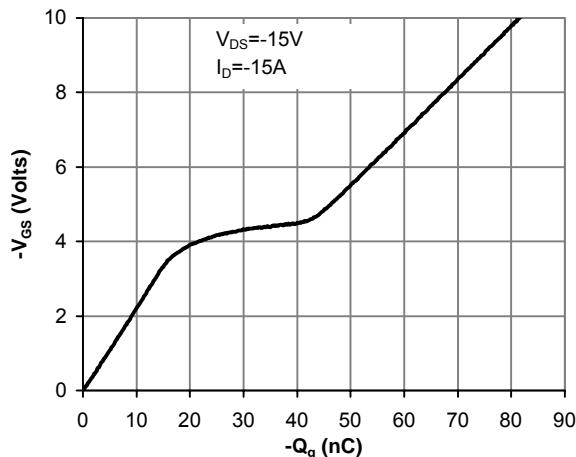


Figure 7: Gate-Charge Characteristics

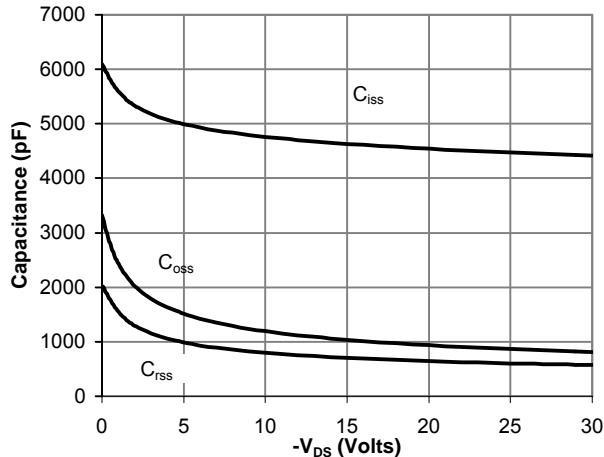


Figure 8: Capacitance Characteristics

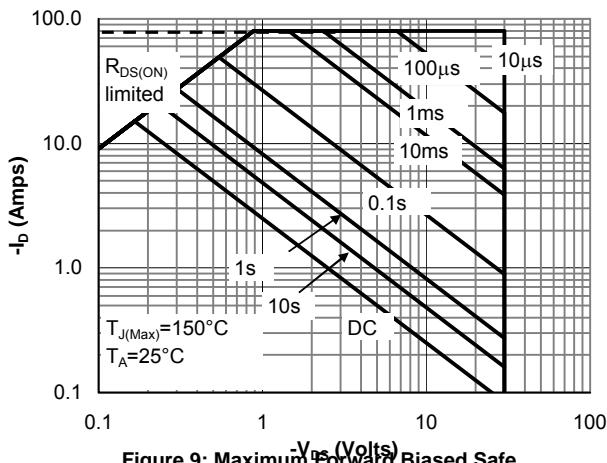


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

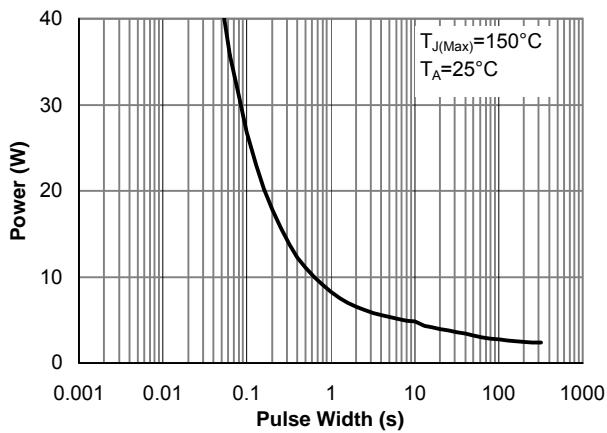


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

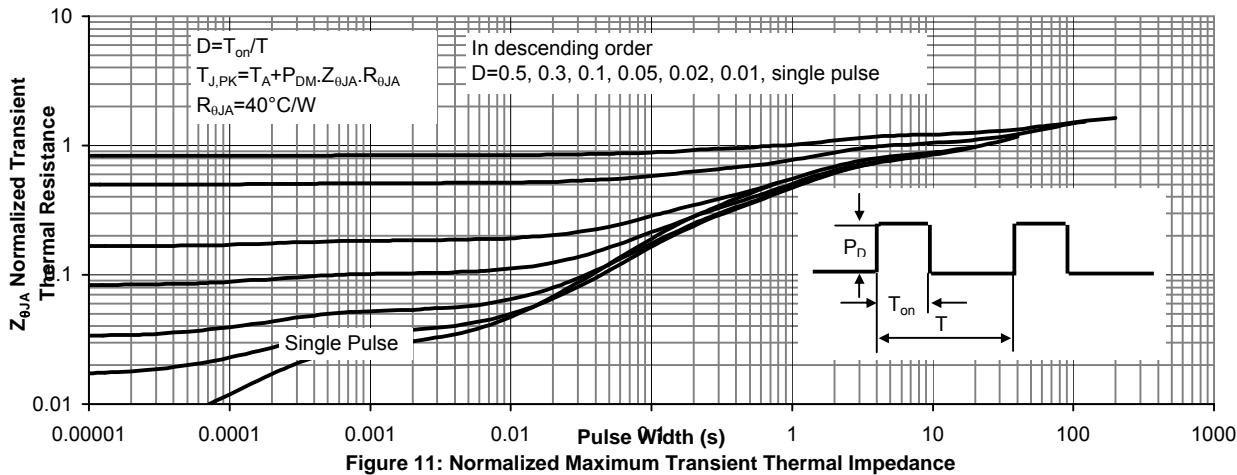


Figure 11: Normalized Maximum Transient Thermal Impedance